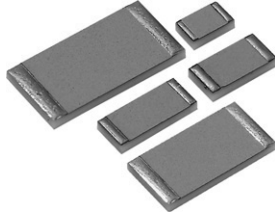


## Ultra High Precision Z-Foil Flip Chip Resistor with TCR of $\pm 0.05$ ppm/°C, 35 % Space Saving vs. Wraparound Design and PCR of 5 ppm at Rated Power



Bottom View

### INTRODUCTION

One of the most important parameters influencing stability is the temperature coefficient of resistance (TCR). Although the TCR of Bulk Metal® Foil resistors is considered extremely low, this characteristic has been further refined over the years.

The VFCP Series utilizes ultra precision Bulk Metal® Z-Foil.

The Z-Foil technology provides a significant reduction to the resistive element's sensitivity to ambient temperature variations (TCR) and to self heating when power is applied (power coefficient).

Along with the inherently low PCR and TCR, Z-Foil technology also provides remarkably improved load life stability, low noise and availability of tight tolerance.

The flip chip configuration provides a substantial PCB space saving of more than 35 % vs. a surface mount chip with wraparound terminations. The VFCP is available in any value within the specified resistance range.

Our application engineering department is available to advise and make recommendations. For non-standard technical requirements and special applications, please contact us.

| TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE |               |   |
|--|---------------|---|
| RESISTANCE VALUE (Ω)                             | TOLERANCE (%) | TYPICAL TCR AND MAX. SPREAD (- 55 °C to + 125 °C, + 25 °C Ref.) |
| 250 to 125K                                      | ± 0.01        | ± 0.2 ± 1.6   |
| 100 to < 250                                     | ± 0.02        | ± 0.2 ± 1.6   |
| 50 to < 100                                      | ± 0.05        | ± 0.2 ± 1.8   |
| 25 to < 50                                       | ± 0.1         | ± 0.2 ± 2.8   |
| 10 to < 25                                       | ± 0.25        | ± 0.2 ± 2.8   |

### FEATURES

- Temperature coefficient of resistance (TCR):  
± 0.05 ppm/°C typical (0 °C to + 60 °C)  
± 0.2 ppm/°C typical (- 55 °C to + 125 °C, + 25 °C ref.)
- Tolerance: to ± 0.01 % (100 ppm)
- Power coefficient "ΔR due to self heating"  
5 ppm at rated power
- Load life stability (70 °C for 2000 h): ± 0.005 % (50 ppm)
- Power rating to: 600 mW at + 70 °C
- Electrostatic discharge (ESD) up to 25 000 V
- Resistance range: 10 Ω to 125 kΩ (for lower and higher values, please contact us)
- Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Non-inductive, non-capacitive design
- Short time overload ≤ 0.005 % (50 ppm)
- Non hot spot design
- Rise time: 1 ns effectively no ringing
- Current noise: - 40 dB
- Voltage coefficient < 0.1 ppm/V
- Non-inductive: < 0.08 μH
- Terminal finishes available: lead (Pb)-free, tin/lead alloy
- Compliant to RoHS directive 2002/95/EC
- Matched sets are available per request
- Prototype quantities available in just 5 working days or sooner. For more information, please contact [foil@vishaypg.com](mailto:foil@vishaypg.com)
- For better performances please contact us

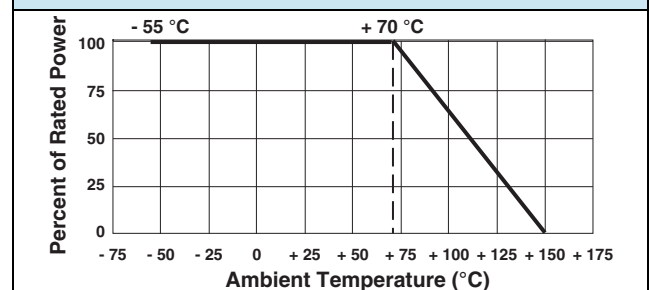


RoHS\*  
COMPLIANT

### APPLICATIONS

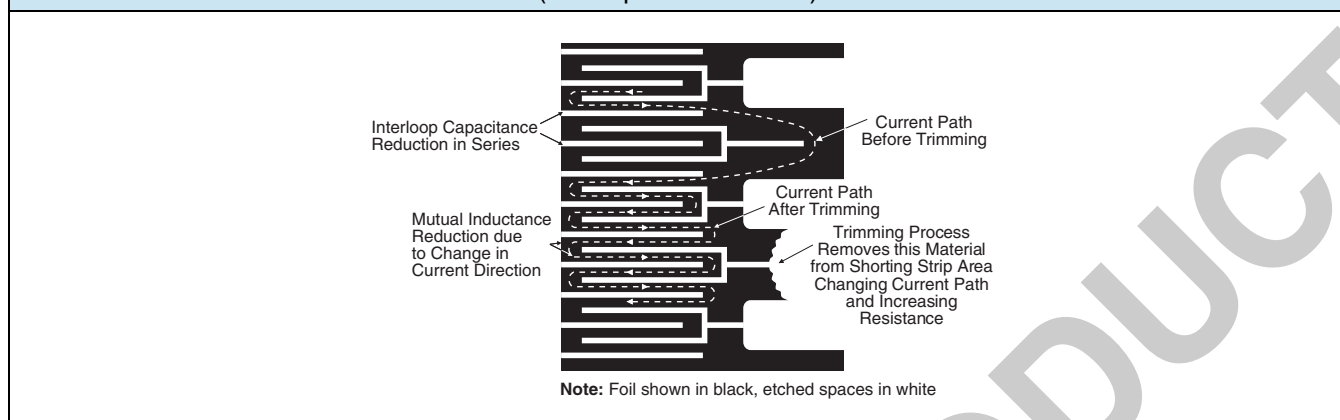
- Automatic test equipment (ATE)
- High precision instrumentation
- Laboratory, industrial and medical
- Audio
- EB applications (electron beam scanning and recording equipment, electron microscopes)
- Military and space
- Airborne
- Down hole instrumentation
- Communication

FIGURE 1 - POWER DERATING CURVE



\* Pb containing terminations are not RoHS compliant, exemptions may apply

**FIGURE 2 - TRIMMING TO VALUES** (Conceptual Illustration)



| TABLE 2 - SPECIFICATIONS |                             |   |                               |                     |
|--------------------------|-----------------------------|---|-------------------------------|---------------------|
| CHIP SIZE                | RATED POWER (mW) at + 70 °C | MAXIMUM VOLTAGE RATING ( $\leq \sqrt{P \times R}$ ) | RESISTANCE RANGE ( $\Omega$ ) | MAXIMUM WEIGHT (mg) |
| 0805                     | 100 mW                      | 28 V  | 10 to 8K                      | 5.2                 |
| 1206                     | 250 mW                      | 79 V  | 10 to 25K                     | 10.3                |
| 1506                     | 300 mW                      | 95 V  | 10 to 30K                     | 12                  |
| 2010                     | 400 mW                      | 167 V   | 10 to 70K                     | 25                  |
| 2512                     | 600 mW                      | 220 V   | 10 to 125K                    | 35                  |

| TABLE 3 - LOAD LIFE STABILITY (+ 70 °C for 2000 h) |   |
|--|---|
| CHIP SIZE  | MAXIMUM $\Delta R$ LIMITS                         |
| 0805   | $\pm 0.005\%$ at 50 mW<br>$\pm 0.01\%$ at 100 mW  |
| 1206   | $\pm 0.005\%$ at 150 mW<br>$\pm 0.01\%$ at 250 mW |
| 1506   | $\pm 0.005\%$ at 150 mW<br>$\pm 0.01\%$ at 300 mW |
| 2010   | $\pm 0.005\%$ at 200mW<br>$\pm 0.01\%$ at 400 mW  |
| 2512   | $\pm 0.005\%$ at 500 mW<br>$\pm 0.01\%$ at 600 mW |

| TABLE 4 - PERFORMANCES                                    |  |                           |  |
|---|--|---------------------------|--|
| TEST OR CONDITION   | MIL-PRF-55342 CHARACTERISTIC E $\Delta R$ LIMITS | TYPICAL $\Delta R$ LIMITS | MAXIMUM $\Delta R$ LIMITS <sup>(1)</sup> |
| Thermal Shock   | $\pm 0.1\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.01\%$ (100 ppm)                   |
| Low Temperature Operation                                 | $\pm 0.1\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.01\%$ (100 ppm)                   |
| Short Time Overload                                       | $\pm 0.1\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.01\%$ (100 ppm)                   |
| High Temperature Exposure                                 | $\pm 0.1\%$                                      | $\pm 0.01\%$ (100 ppm)    | $\pm 0.02\%$ (200 ppm)                   |
| Resistance to Soldering Heat                              | $\pm 0.2\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.015\%$ (150 ppm)                  |
| Moisture Resistance                                       | $\pm 0.2\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.02\%$ (200 ppm)                   |
| Load Life Stability + 70 °C for 2000 hours at Rated Power | $\pm 0.5\%$                                      | $\pm 0.005\%$ (50 ppm)    | $\pm 0.01\%$ (100 ppm)                   |

**Note**

<sup>(1)</sup> As shown + 0.01 W to allow for measurement errors at low values.

**TABLE 5 - DIMENSIONS AND LAND PATTERN** in inches (millimeters)

| CHIP SIZE | BOTTOM VIEW (showing terminals for mounting) |                     |                      | LAND PATTERN        |              |              |              |
|-----------|--|---------------------|----------------------|---------------------|--------------|--------------|--------------|
|           | L<br>± 0.005 (0.13)                          | W<br>± 0.005 (0.13) | THICKNESS<br>MAXIMUM | D<br>± 0.005 (0.13) | Z            | G            | X            |
| 0805      | 0.079 (2.01)                                 | 0.049 (1.24)        | 0.025 (0.64)         | 0.010 (0.25)        | 0.078 (1.98) | 0.053 (1.35) | 0.049 (1.24) |
| 1206      | 0.126 (3.20)                                 | 0.062 (1.57)        | 0.025 (0.64)         | 0.015 (0.38)        | 0.125 (3.18) | 0.090 (2.29) | 0.062 (1.57) |
| 1506      | 0.150 (3.81)                                 | 0.062 (1.57)        | 0.025 (0.64)         | 0.012 (0.30)        | 0.150 (3.81) | 0.120 (3.05) | 0.062 (1.57) |
| 2010      | 0.200 (5.08)                                 | 0.100 (2.54)        | 0.025 (0.64)         | 0.020 (0.51)        | 0.199 (5.05) | 0.153 (3.89) | 0.100 (2.54) |
| 2512      | 0.250 (6.35)                                 | 0.126 (3.20)        | 0.025 (0.64)         | 0.024 (0.61)        | 0.250 (6.35) | 0.196 (4.98) | 0.126 (3.20) |

**Notes**

- Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction
- Vacuum pick up is recommended for handling
- Soldering iron is not applicable

**FIGURE 3 - CHIP CONFIGURATION**



**FIGURE 4 - TYPICAL RESISTANCE/TEMPERATURE CURVE**  
(for more details, see table 1)

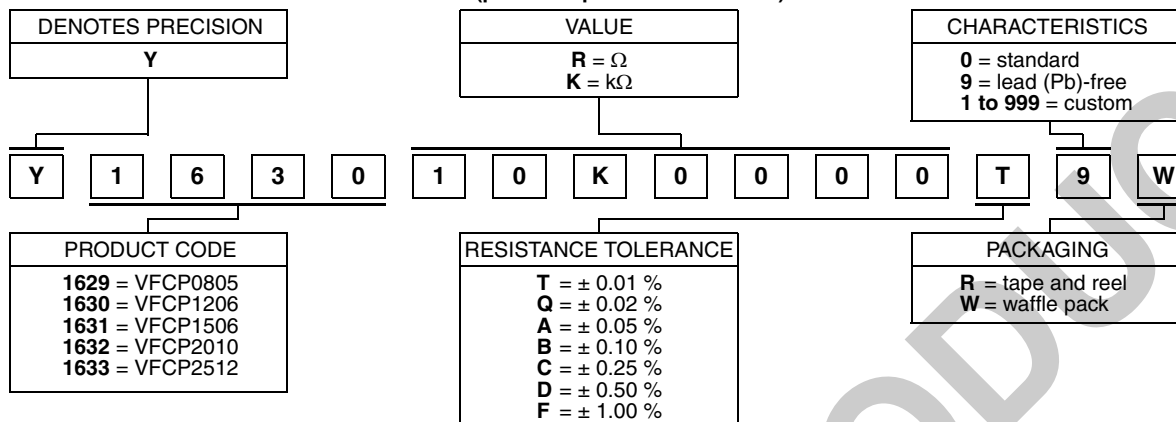


**Note**

- The TCR values for < 100 Ω are influenced by the termination composition and result in deviation from this curve

**TABLE 6 - GLOBAL PART NUMBER INFORMATION (1)**

NEW GLOBAL PART NUMBER: Y163010K0000T9W (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y1630 10K0000 T 9 W:

TYPE: VFCP1206

VALUE: 10.0 kΩ

ABSOLUTE TOLERANCE: ± 0.01 %

TERMINATION: lead (Pb)-free

PACKAGING: waffle pack

HISTORICAL PART NUMBER: VFCP1206 10K000 TCR0.2 T S W (will continue to be used)

| VFCP1206   | 10K000      | TCR0.2         | T  | S                                  | W                                    |
|--|-------------|----------------|--|------------------------------------|--------------------------------------|
| MODEL  | OHMIC VALUE | TCR            | RESISTANCE TOLERANCE   | TERMINATION                        | PACKAGING                            |
| VFCP0805<br>VFCP1206<br>VFCP1506<br>VFCP2010<br>VFCP2512 | 10.0 kΩ     | Characteristic | T = ± 0.01 %<br>Q = ± 0.02 %<br>A = ± 0.05 %<br>B = ± 0.10 %<br>C = ± 0.25 %<br>D = ± 0.50 %<br>F = ± 1.00 % | S = lead (Pb)-free<br>B = tin/lead | T = tape and reel<br>W = waffle pack |

**Note**

(1) For non-standard requests, please contact application engineering.

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